SFH 320 FA

TOPLED®

Silicon NPN Phototransistor in SMT TO-PLED®-Package







- Electronic Equipment

- White Goods

Features:

- Package: black epoxy

- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

- Spectral range of sensitivity: (typ) 750 ... 1120 nm

High linearity

- P-LCC-2 package

- Available in groups

- Suitable for all soldering methods

Ordering Information

Туре	Photocurrent V_{CE} = 5 V; λ = 950 nm; E_{e} = 0.1 mW/cm ² I_{PCE}	Ordering Code
SFH 320 FA-4-Z	40 80 μΑ	Q65110A1836
SFH 320 FA-3-Z	25 50 μΑ	Q65110A2470
SFH 320 FA-Z	16 80 μΑ	Q65110A2472
SFH 320 FA-3/4-Z	25 80 μΑ	Q65110A2475

Only one bin within one packing unit (variation less than 2:1)





Maximum Rating	S
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T.	=	25	$^{\circ}C$
Ι,	_	20	\circ

Parameter	Symbol		Values
Operating temperature	T _{op}	min. max.	-40 °C 100 °C
Storage temperature	T_{stg}	min. max.	-40 °C 100 °C
Collector-emitter voltage	V _{CE}	max.	35 V
Collector current	I _c	max.	15 mA
Collector surge current τ ≤ 10 μs	I _{cs}	max.	75 mA
Total power dissipation	P _{tot}	max.	165 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV



Characteristics

T.	=	25	$^{\circ}C$
Ι,	_	20	\circ

Parameter	Symbol		Values
Wavelength of max sensitivity	$\lambda_{ m Smax}$	typ.	980 nm
Spectral range of sensitivity	λ _{10%}	typ.	750 1120 nm
Chip dimensions	LxW	typ.	0.45 x 0.45 mm x mm
Radiant sensitive area Ø = 220 μm	А	typ.	0.038 mm²
Half angle	φ	typ.	60 °
Dark current V _{CE} = 20 V; E = 0	I _{CE0}	typ. max.	1 nA 50 nA
Rise time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t,	typ.	7 µs
Fall time $I_c = 1 \text{ mA}$; $V_{cc} = 5 \text{ V}$; $R_L = 1 \text{ k}\Omega$	t _f	typ.	7 µs
Collector-emitter saturation voltage $^{1)}$ $I_{\rm C} = I_{\rm PCE,min} \times 0.3$; $E_{\rm e} = 0.1 \rm mW/cm^2$	V_{CEsat}	typ.	150 mV
Capacitance $V_{CE} = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C_{CE}	typ.	5 pF
Thermal resistance junction ambient real	R_{thJA}	max.	450 K / W

Grouping

T_A = 25 °C

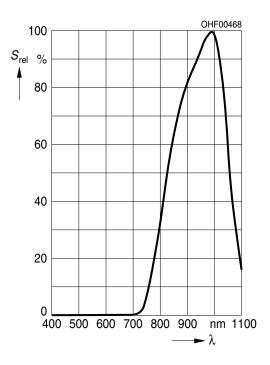
Group	Photocurrent V_{CE} = 5 V; λ = 950 nm; E_{e} = 0.1 mW/cm ² min. I_{PCE}	Photocurrent V_{CE} = 5 V; λ = 950 nm; E_{e} = 0.1 mW/cm ² max. I_{PCE}
2	16 μΑ	32 µA
3	25 μΑ	50 μΑ
4	40 μΑ	80 μΑ

Only one bin within one packing unit (variation less than 2:1).



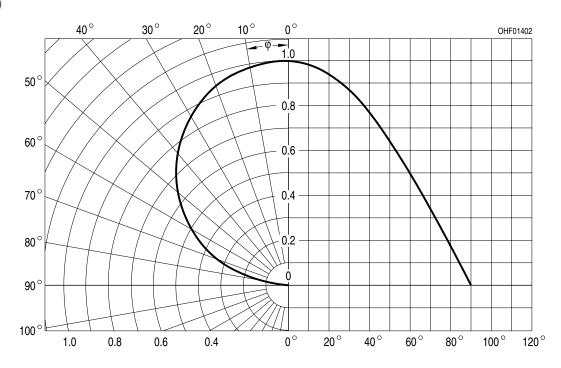
Relative Spectral Sensitivity 2), 3)

 $S_{rel} = f(\lambda)$



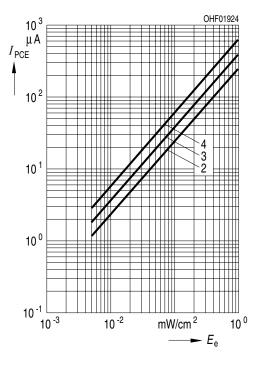
Directional Characteristics 2), 3)

 $S_{rel} = f(\phi)$



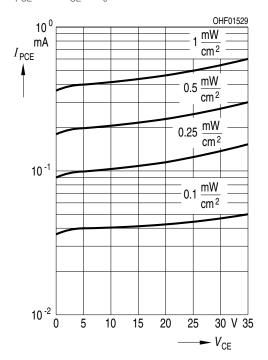
Photocurrent 2), 3)

$$I_{PCE} = f(E_e)$$
; $V_{CE} = 5 V$



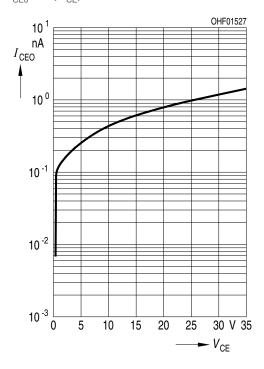
Photocurrent 2), 3)

$$I_{PCE} = f(V_{CE}), E_e = Parameter$$



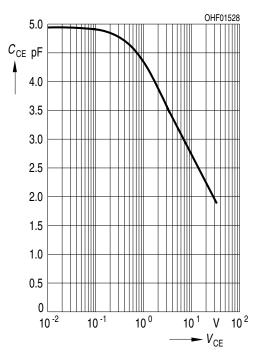
Dark Current 2), 3)

$$I_{CE0} = f(V_{CE})$$
; $E = 0$;



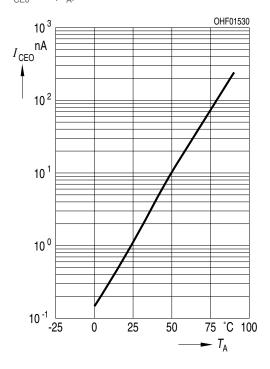
Collector-Emitter Capacitance 2), 3)

 $C_{CE} = f(V_{CE}); f = 1 MHz; E = 0;$



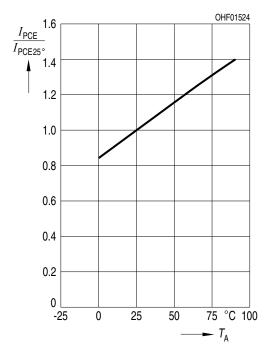
Dark Current 2)

$$I_{CE0} = f(T_A); E = 0$$



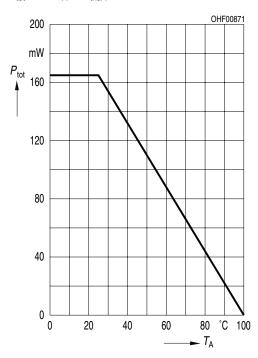
Photocurrent 2)

$$I_{PCE,rel} = f(T_A); V_{CE} = 5 V$$



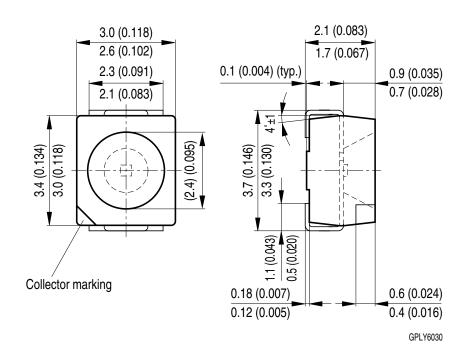
Power Consumption

$$P_{tot} = f(T_A); R_{thJA} = 450 K/W$$





Dimensional Drawing 4)

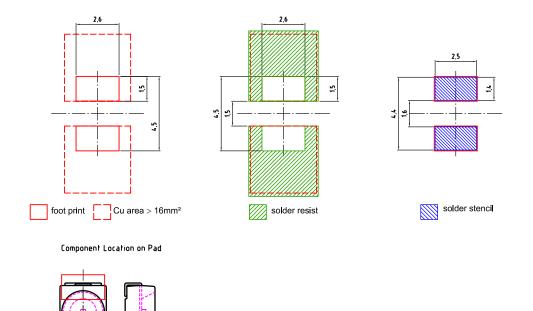


Approximate Weight: 35.0 mg

Package marking: Collector



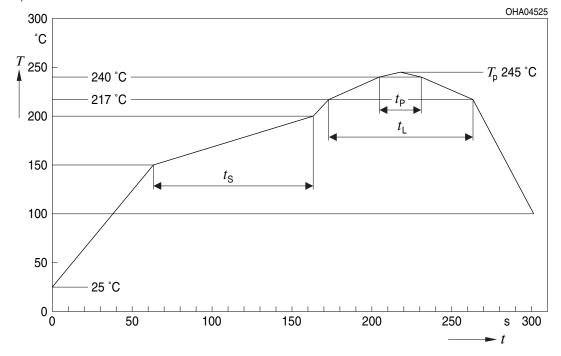
Recommended Solder Pad 4)



E062.3010.01 -02

Reflow Soldering Profile

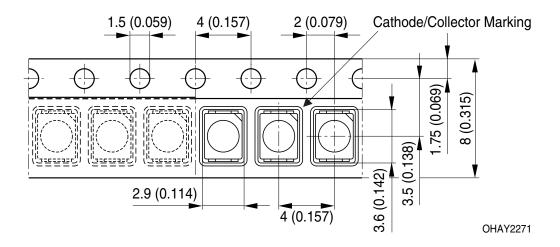
Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb	-Free (SnAgCu) Ass	embly	Unit
	,	Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t _S T _{Smin} to T _{Smax}	t _s	60	100	120	S
Ramp-up rate to peak*) T_{Smax} to T_{P}			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_		80	100	S
Peak temperature	T _P		245	260	°C
Time within 5 °C of the specified peak temperature T _P - 5 K	t _P	10	20	30	S
Ramp-down rate* T _p to 100 °C			3	6	K/s
Time 25 °C to T _P				480	S

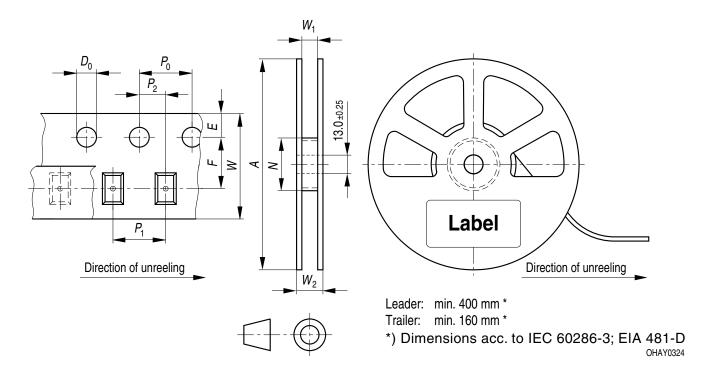
All temperatures refer to the center of the package, measured on the top of the component

Taping 4)



^{*} slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Tape and Reel 5)

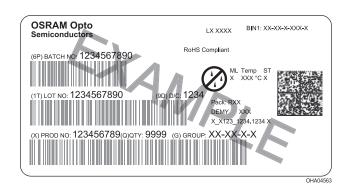


Reel dimensions [mm]

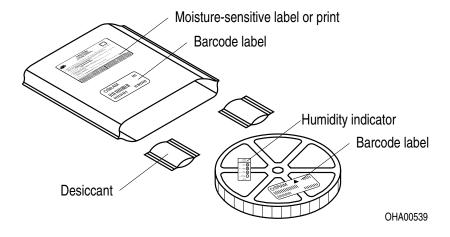
Α	W	N_{\min}	W_1	$W_{2\text{max}}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	2000
330 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	8000



Barcode-Product-Label (BPL)



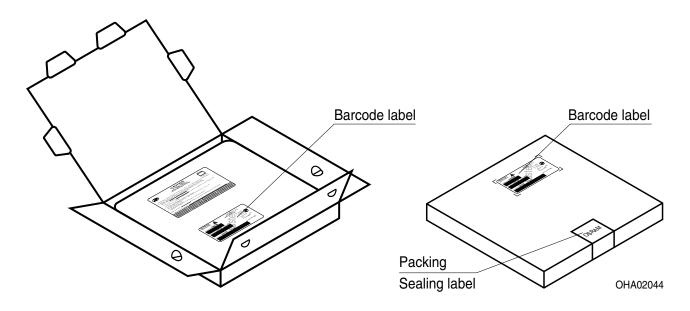
Dry Packing Process and Materials 4)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Transportation Packing and Materials 4)



Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm
352 ± 5 mm	352 ± 5 mm	33 ± 5 mm



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



Disclaimer

Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the OSRAM OS Webside.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

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Glossary

- 1) **IPCEmin**: I_{PCEmin} is the min. photocurrent of the specified group.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Testing temperature: $T_A = 25^{\circ}C$
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ⁵⁾ **Tape and Reel**: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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